- Contains Six Flip-Flops With Single-Rail Outputs
- Buffered Clock and Direct Clear Inputs
- Applications Include: Buffer/Storage Registers Shift Registers

**Pattern Generators** 

- Fully Buffered Outputs for Maximum Isolation From External Disturbances
- Package Options Include Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs

#### (TOP VIEW) CLR 16 V<sub>CC</sub> 1Q [ 2 15 **6**Q 3 1D Π 14**∏** 6D 4 13**∏** 5D 2D | 12 1 5Q 2Q 5 11 | 4D 3D 6 10 1 4Q 7 3Q 9 CLK **GND**

D OR N PACKAGE

#### description

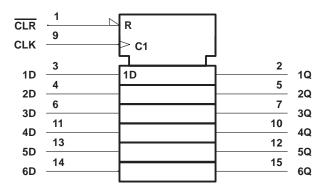
This monolithic, positive-edge-triggered flip-flop utilizes TTL circuitry to implement D-type flip-flop logic with a direct clear (CLR) input. Information at the data (D) inputs meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock (CLK) input is at either the high or low level, the D-input signal has no effect at the output.

The SN74F174A is characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each flip-flop)

|     | INPUTS     |   | OUTPUT         |
|-----|------------|---|----------------|
| CLR | CLK        | D | Q              |
| Н   | L          | Х | Q <sub>0</sub> |
| Н   | $\uparrow$ | Н | Н              |
| Н   | $\uparrow$ | L | L              |
| L   | Х          | Χ | L              |

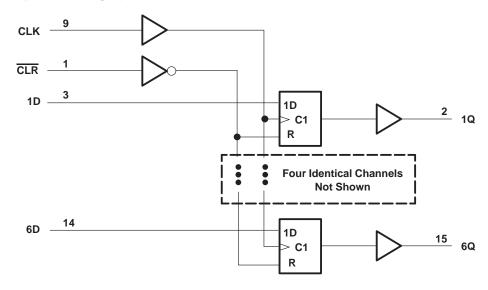
## logic symbol†



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>            | 0.5 V to 7 V                      |
|--|-----------------------------------|
| Input voltage range, V <sub>I</sub> (see Note 1) | 1.2 V to 7 V                      |
| Input current range                              | 30 mA to 5 mA                     |
| Voltage applied to any output in the high state  | $\dots$ -0.5 V to V <sub>CC</sub> |
| Current into any output in the low state         | 40 mA                             |
| Operating free-air temperature range             | 0°C to 70°C                       |
| Storage temperature range                        | . −65°C to 150°C                  |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

|                 |                                | MIN | NOM | MAX | UNIT |
|-----------------|--------------------------------|-----|-----|-----|------|
| VCC             | Supply voltage                 | 4.5 | 5   | 5.5 | V    |
| VIH             | High-level input voltage       | 2   |     |     | V    |
| VIL             | Low-level input voltage        |     |     | 0.8 | V    |
| lik             | Input clamp current            |     |     | -18 | mA   |
| IOH             | High-level output current      |     |     | -1  | mA   |
| I <sub>OL</sub> | Low-level output current       |     |     | 20  | mA   |
| TA              | Operating free-air temperature | 0   |     | 70  | °C   |



NOTE 1: The input-voltage ratings may be exceeded provided the input-current ratings are observed.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        | TEST CON                 | MIN                      | TYP <sup>†</sup> | MAX | UNIT  |    |
|------------------|--------------------------|--------------------------|------------------|-----|-------|----|
| VIK              | $V_{CC} = 4.5 V,$        | I <sub>I</sub> = – 18 mA |                  |     | - 1.2 | V  |
| Vou              | $V_{CC} = 4.5 V,$        | $I_{OH} = -1 \text{ mA}$ | 2.5              | 3.4 |       | V  |
| Voн              | $V_{CC} = 4.75 V,$       | $I_{OH} = -1 \text{ mA}$ | 2.7              |     |       | V  |
| V <sub>OL</sub>  | $V_{CC} = 4.5 V,$        | $I_{OL} = 20 \text{ mA}$ |                  | 0.3 | 0.5   | V  |
| ΙĮ               | $V_{CC} = 5.5 V,$        | V <sub>I</sub> = 7 V     |                  |     | 0.1   | mA |
| lін              | $V_{CC} = 5.5 V,$        | V <sub>I</sub> = 2.7 V   |                  |     | 20    | μΑ |
| I <sub>IL</sub>  | $V_{CC} = 5.5 V,$        | V <sub>I</sub> = 0.5 V   |                  |     | - 0.6 | mA |
| los <sup>‡</sup> | $V_{CC} = 5.5 V,$        | VO = 0                   | - 60             |     | - 150 | mA |
| Іссн             | V <sub>CC</sub> = 5.5 V, | See Note 2               |                  | 30  | 45    | mA |
| ICCL             | V <sub>CC</sub> = 5.5 V, | See Note 3               |                  | 39  | 55    | mA |

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

#### timing requirements

|                 |                         |                  | V <sub>CC</sub> = | V <sub>CC</sub> = 5 V,<br>T <sub>A</sub> = 25°C |     | V <sub>CC</sub> = 4.5 V to 5.5 V,<br>T <sub>A</sub> = MIN to MAX§ |     |  |
|-----------------|-------------------------|------------------|-------------------|---|-----|---|-----|--|
|                 |                         |                  | MIN               | MAX   | MIN | MAX   |     |  |
| fclock          | Clock frequency         |                  | 0                 | 100   | 0   | 80  | MHz |  |
|                 |                         | CLK high         | 4                 |   | 4   |   |     |  |
| t <sub>W</sub>  | Pulse duration          | CLK low          | 6                 |   | 6   |   | ns  |  |
|                 |                         | CLR low          | 5                 |   | 5   |   |     |  |
|                 | Output form hafare OLKA | Data high or low | 4.5               |   | 4.5 |   |     |  |
| t <sub>su</sub> | Setup time before CLK↑  | CLR high¶        | 5                 |   | 5   |   | ns  |  |
| th              | Hold time after CLK↑    | Data high or low | 0.5               |   | 1   |   | ns  |  |

<sup>§</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

#### switching characteristics (see Note 4)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | C <sub>L</sub><br>R <sub>L</sub> | C = 5 V,<br>= 50 pF<br>= 500 Ω<br>= 25°C | ,   | V <sub>CC</sub> = 4.5<br>C <sub>L</sub> = 50 pl<br>R <sub>L</sub> = 500 Q<br>T <sub>A</sub> = MIN | 2,  | UNIT |
|------------------|-----------------|----------------|----------------------------------|--|-----|---|-----|------|
|                  |                 |                | MIN                              | TYP                                      | MAX | MIN   | MAX |      |
| f <sub>max</sub> |                 |                | 100                              | 140                                      |     | 80  |     | MHz  |
| <sup>t</sup> PLH | CLK             | Any Q          | 2.7                              | 4.5                                      | 8   | 2.7   | 9   | ns   |
| t <sub>PHL</sub> | OLK             | Ally Q         | 3.4                              | 4.2                                      | 10  | 3.3   | 11  | 115  |
| <sup>t</sup> PHL | CLR             | Any Q          | 4.2                              | 6.3                                      | 14  | 4.2   | 15  | ns   |

NOTE 4: Load circuits and waveforms are shown in Section 1.



<sup>‡</sup> Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTES: 2. I<sub>CCH</sub> is measured with all outputs open, all data inputs and enable input at 4.5 V, and the clock input at 4.5 V after being momentarily grounded.

<sup>3.</sup> ICCL is measured with all outputs open, all data inputs and enable input at 0 V, and the clock input at 4.5 V after being momentarily grounded.

 $<sup>\</sup>P$  Inactive-state setup time is also referred to as recovery time.



#### PACKAGE OPTION ADDENDUM



10-Dec-2020

#### **PACKAGING INFORMATION**

| Orderable Device | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| SN74F174AD       | ACTIVE     | SOIC         | D                  | 16   | 40             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | F174A                   | Samples |
| SN74F174ADR      | ACTIVE     | SOIC         | D                  | 16   | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | F174A                   | Samples |
| SN74F174ADRE4    | ACTIVE     | SOIC         | D                  | 16   | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | F174A                   | Samples |
| SN74F174AN       | ACTIVE     | PDIP         | N                  | 16   | 25             | RoHS & Green | NIPDAU                        | N / A for Pkg Type | 0 to 70      | SN74F174AN              | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## PACKAGE OPTION ADDENDUM

10-Dec-2020

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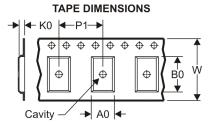
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# PACKAGE MATERIALS INFORMATION

www.ti.com 29-Jul-2011

## TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device      | Package<br>Type | Package<br>Drawing |    |      | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74F174ADR | SOIC            | D                  | 16 | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |

**PACKAGE MATERIALS INFORMATION** 

www.ti.com 29-Jul-2011



#### \*All dimensions are nominal

| Device      | Package Type | Package Type Package Drawing Pins SPQ |    | SPQ  | Length (mm) | Width (mm) | Height (mm) |  |
|-------------|--------------|---------------------------------------|----|------|-------------|------------|-------------|--|
| SN74F174ADR | SOIC         | D                                     | 16 | 2500 | 333.2       | 345.9      | 28.6        |  |

# D (R-PDS0-G16)

## PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



# D (R-PDSO-G16)

# PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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